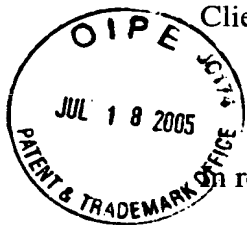


Attorney Docket: 021906-0306952
Client Reference: PIA30959/DBE/US-SE



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

On re PATENT APPLICATION of:

Confirmation Number: 6290

LEE

Application No.: 10/730,941

Group Art Unit: 2815

Filed: December 10, 2003

Examiner: M. LANDAU

Title: BARRIER STRUCTURE FOR COPPER METALLIZATION AND METHOD FOR
THE MANUFACTURE THEREOF

July 18, 2005

RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop Non-Fee Amendments
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated June 27, 2005, Applicant hereby elects
Group I, directed to claims 1-6, drawn to a metallization structure, classified in class 257,
subclass 751.

Please charge or credit any fees associated with the submission of this paper to
Deposit Account Number 033975.

Respectfully submitted,

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